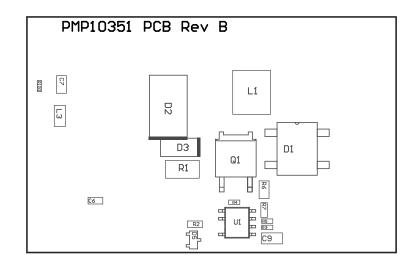


COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE	BOARD #: PMP10351	REV: B	SVN REV	: Not In VersionControl
IGNORE -> Top Overlay				
PLOT NAME = Top Assembly Drawing	GENERATED : 9/15/2	2014 7:00:29	AM	TEXAS INSTRUMENTS



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM BOTTOM SIDE	BOARD #: PMP10351	REV: B	SVN REV	: Not In VersionControl
	Bottom Overlay <- ANNAI			
PLOT NAME = Bottom Assembly Drawing	GENERATED : 9/15/2	2014 7:00:30	AM	TEXAS INSTRUMENTS

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